

MiniSKiiP® 1

Sixpack

SKiiP 12AC12T7V1

Features*

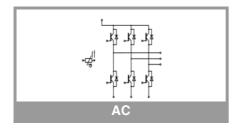
- 1200V Generation 7 IGBTs (T7)
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

Remarks

- Max. case temperature limited to $T_C=T_S=125\ ^{\circ}C$
- Product reliability results valid for T_j≤150 °C (recommended T_{j,op}=-40...+150 °C)
 MiniSKiiP "Technical Explanations"
- MiniSKiiP "Technical Explanations" and "Mounting Instructions" are part of the data sheet. Please refer to both documents for further information.
- For storage and case temperature with TIM see document: "Technical Explanations Thermal Interface Materials"

Absolute	Maximum Ratings	s		
Symbol	Conditions		Values	Unit
Inverter -	IGBT			
V_{CES}	T _j = 25 °C		1200	V
Ic	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	26	Α
	I -	T _s = 100 °C	21	Α
I _C	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	28	Α
	T _j = 175 °C	T _s = 100 °C	23	Α
I _{Cnom}		•	15	Α
I _{CRM}			30	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 175 °C	7	μs
T_j			-40 175	°C
Inverse -	Diode			
I _F	λ _{paste} =0.8 W/(mK)	T _s = 70 °C	19	Α
	T _j = 175 °C	T _s = 100 °C	16	Α
I _F	λ _{paste} =2.5 W/(mK)	T _s = 70 °C	21	Α
	T _j = 175 °C	T _s = 100 °C	17	Α
I _{FRM}		•	30	Α
I _{FSM}	$t_p = 10 \text{ ms}, \sin 180^\circ$	°, T _j = 150 °C	65	Α
Tj			-40 175	°C
Module	•		•	
I _{t(RMS)}	T _{terminal} = 80 °C, 20	A per spring	40	Α
T _{stg}	module without TIN	Л	-40 125	°C
V _{isol}	AC sinus 50 Hz, t =	= 1 min	2500	V

Characteristics								
Symbol	Conditions	min.	typ.	max.	Unit			
Inverter - IGBT								
V _{CE(sat)}	I _C = 15 A	T _j = 25 °C		1.60	1.75	V		
	V _{GE} = 15 V	T _j = 150 °C		1.82	1.96	V		
	chiplevel	T _j = 175 °C		1.86	2.00	V		
V_{CE0}		T _j = 25 °C		0.90	1.00	V		
	chiplevel	T _j = 150 °C		0.75	0.83	V		
		T _j = 175 °C		0.72	0.80	V		
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		47	50	mΩ		
		T _j = 150 °C		71	75	mΩ		
		T _j = 175 °C		76	80	mΩ		
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_{C} = 0.33$	3 mA	5.15	5.8	6.45	V		
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	$200 \text{ V}, \text{ T}_{j} = 25 ^{\circ}\text{C}$			1	mA		
C _{ies}	V 05.V	f = 1 MHz		2.80		nF		
C _{oes}	$V_{CE} = 25 \text{ V}$ $V_{GE} = 0 \text{ V}$	f = 1 MHz		0.04		nF		
C _{res}	VGE - O V	f = 1 MHz		0.01		nF		
Q_G	V _{GE} = - 8V + 15 V			210		nC		
R _{Gint}	T _j = 25 °C			0		Ω		





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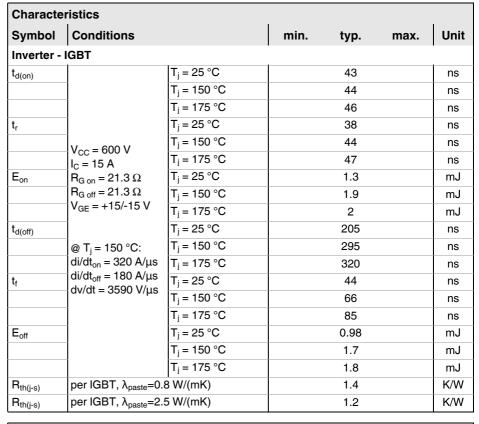
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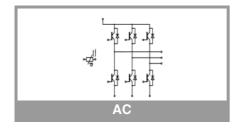
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Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse -	Diode					
$V_F = V_{EC}$	I _F = 15 A	T _j = 25 °C		2.38	2.71	V
	$V_{GE} = 0 V$	T _j = 150 °C		2.44	2.77	V
	chiplevel	T _j = 175 °C		2.26	2.58	V
V_{F0}		T _j = 25 °C		1.30	1.50	V
	chiplevel	T _j = 150 °C		0.90	1.10	V
		T _j = 175 °C		0.82	0.98	V
r _F		T _j = 25 °C		72	81	mΩ
	chiplevel	T _j = 150 °C		103	111	mΩ
		T _j = 175 °C		96	107	mΩ
I _{RRM}		T _j = 25 °C		9		Α
		T _j = 150 °C		11		Α
		T _j = 175 °C		13		Α
Q _{rr}		T _j = 25 °C		0.9		μС
		T _j = 150 °C		2.1		μС
	@ T _i = 150 °C:	T _j = 175 °C		2.4		μС
E _{rr}	di/dt _{off} = 350 A/μs	T _j = 25 °C		0.27		mJ
		T _j = 150 °C		0.81		mJ
		T _j = 175 °C		1.1		mJ
R _{th(j-s)}	per Diode, λ _{paste} =0	.8 W/(mK)		1.78		K/W
R _{th(j-s)}	per Diode, λ _{paste} =2	.5 W/(mK)		1.53		K/W
Module						
L _{CE}				-		nΗ
Ms	to heat sink		2		2.5	Nm
W				30		g





Characteristics						
Symbol	Conditions	min.	typ.	max.	Unit	
Temperati	ure Sensor				_	
R ₁₀₀	T _r =100°C (R ₂₅ =1000Ω)		1670 ± 3%		Ω	
R _(T)	$\begin{aligned} &R_{(T)} = 1000\Omega[1 + A(T - 25^{\circ}C) + B(T - 25^{\circ}C)^{2}] \\ , &A = 7.635^{*} 10^{-3^{\circ}}C^{-1}, \\ &B = 1.731^{*} 10^{-5^{\circ}}C^{-2} \end{aligned}$					

Creepage distance (spring to spring) between temperature sensor and phase W = 2.9 mm (CTI 600)

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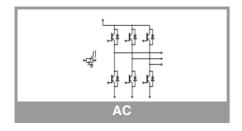
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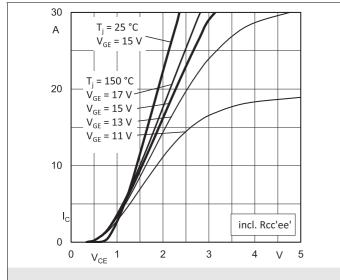


Fig. 1: Typ. output characteristic

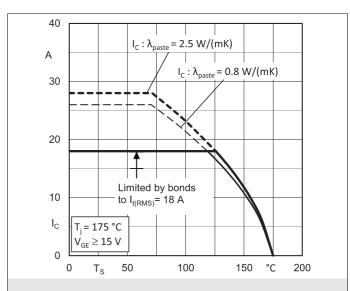


Fig. 2: Rated current vs. temperature $I_C = f(T_S)$

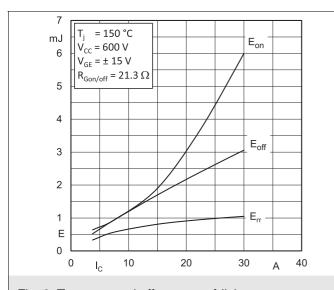


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

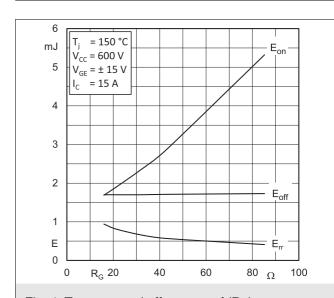


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

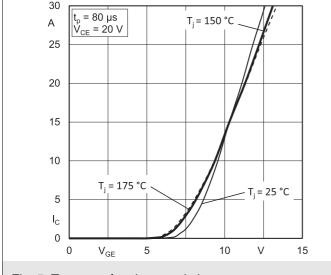


Fig. 5: Typ. transfer characteristic

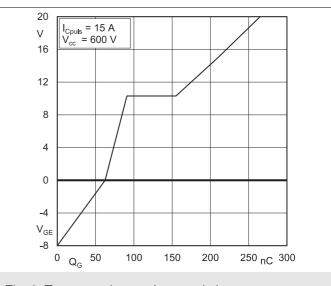


Fig. 6: Typ. gate charge characteristic

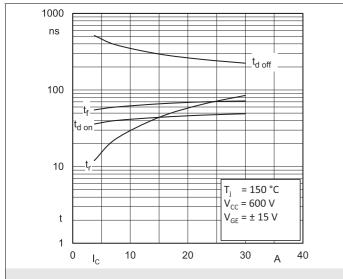


Fig. 7: Typ. switching times vs. I_{C}

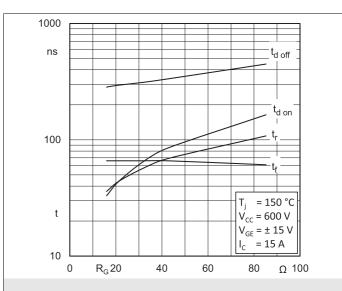


Fig. 8: Typ. switching times vs. gate resistor R_G

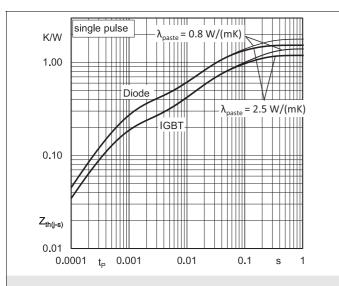


Fig. 9: Transient thermal impedance

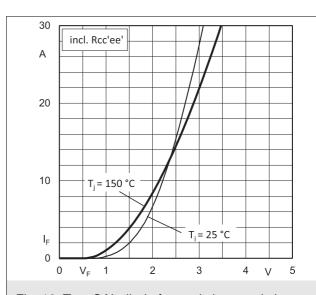


Fig. 10: Typ. CAL diode forward characteristic

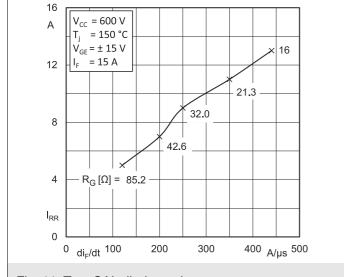


Fig. 11: Typ. CAL diode peak reverse recovery current

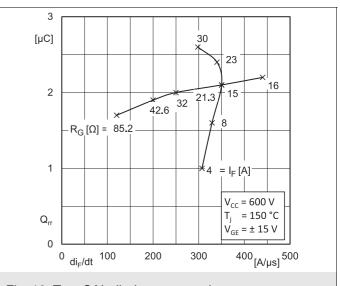
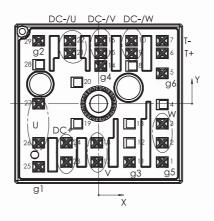


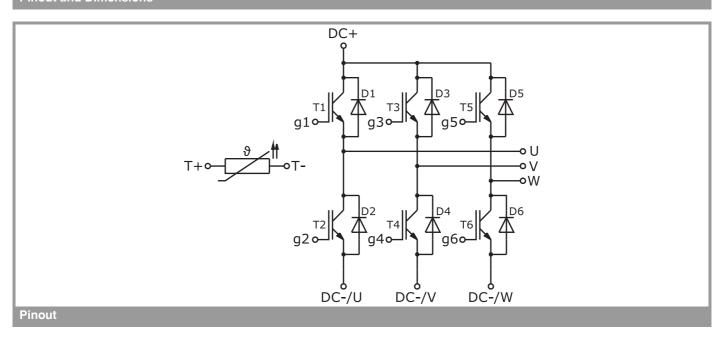
Fig. 12: Typ. CAL diode recovery charge

Pin out							
Pin	Х	Y	Function	Pin	Х	Υ	Function
1	15,93	-14,6	g5	16	0,53	15,8	DC-/V
2	15,93	-9,8	W	17	-0,48	-14,6	V
3	15,93	-5	W	18	-0,48	-9,8	V
4				19			
5	15,93	7,63	g6	20			
6	15,93	12,63	T+	21	-7,18	12,63	DC-/U
7	15,93	15,8	T-	22	-7,18	15,8	DC-/U
8				23	-8,08	-14,6	DC+
9	8,23	12,63	DC-/W	24	-8,08	-9,8	DC+
10	8,23	15,8	DC-/W	25	-15,03	-15,8	g1
11	7,73	-14,6	g3	26	-15,03	-9,8	U
12				27	-15,03	0	U
13				28			
14	0,53	9,45	g4	29	-15,03	15,8	g2
15	0,53	12,63	DC-/V				

all values in mm



Pinout and Dimensions



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

*IMPORTANT INFORMATION AND WARNINGS

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